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Local Schottky contacts of embedded Ag nanoparticles in $\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ stacks on Si: a design to enhance field effect passivation of Si junctions

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Abstract

This paper describes an original design leading to the field effect passivation of Si n^+ -p junctions. Ordered Ag nanoparticle (Ag-NP) arrays with optimal size and coverage fabricated by means of nanosphere lithography and thermal evaporation, were embedded in ultrathin- $\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ stacks on the top of implanted Si n^+ -p junctions, to achieve effective surface passivation. One way to characterize surface passivation is to use photocurrent, sensitive to recombination centers. We evidenced an improvement of photocurrent by a factor of 5 with the presence of Ag NPs. Finite-difference time-domain (FDTD) simulations combining with semi-quantitative calculations demonstrated that such gain was mainly due to the enhanced field effect passivation through the depleted region associated with the Ag-NPs/Si Schottky contacts.

Keywords: field effect passivation, silver nanoparticles, $\text{Al}_2\text{O}_3/\text{SiN}_x$ stacks, FDTD simulation

1. Introduction

Recombination process in n-p (or p-n) junction mainly through defects [1] is a bottleneck to overcome in order to improve the efficiency of light absorption and its conversion into photocurrent, with solar cells as one main application. First, a variety of approaches has been applied to increase light absorption, such as surface texturing and light frequency conversion [2–4]. In particular, research for light trapping has focused on the surface plasmons technology via metallic

nanoparticles (NPs) over the past decades [5, 6]. It has been established that surface plasmons induced by light illumination on noble metallic NPs result in scattering or absorption of light [7, 8]. Furthermore, light trapping can be optimized by engineering the size, shape and density of NPs [9–12]. This area of research is still very active and many questions remained open [13]. As a result, there is a need to improve the fabrication process of NP arrays to achieve optimized coverage. One approach is to use the nanosphere lithography (NSL) that is known to be a low-cost and high-efficiency fabrication technique for the creation of NP arrays with a controlled size and coverage rate [14]. Recently, Gao *et al*

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have demonstrated that this method has large area capability and compatibility with various types of substrates, which could be further applied in the industry [15].

Once light absorption is optimized, it is also important to improve the surface passivation [16]. In general, metallic NPs could be embedded in a passivation layer to hinder the formation of metallic NP recombination centers and to prevent the oxidation of metal [17]. It was found that the Al_2O_3 films deposited by atomic layer deposition (ALD) demonstrated excellent passivation effect comparing with the widely used passivation layers such as thermally grown SiO_2 [18] and plasma-enhanced chemical vapor deposited (PECVD) $\text{SiN}_x\text{:H}$ [19], taking advantage of the unique features of precise growth control, high uniformity and excellent conformity of ALD deposition [20]. Al_2O_3 films combine a high level of chemical passivation with an effective field-effect passivation, which is generated by a high density of negative fixed charges in the Al_2O_3 [21, 22]. Some earlier works showed that the field-effect passivation remained high down to an Al_2O_3 thickness of 2 nm, while the chemical passivation was deteriorated [23]. In that case, effective chemical passivation can be achieved by the diffusion of hydrogen from an additional $\text{SiN}_x\text{:H}$ layer to the Si interface. As a result, stacks of an ultrathin Al_2O_3 tunneling layer (1–2 nm) in combination with a capping layer such as $\text{SiN}_x\text{:H}$ have showed promising passivation results for both *p* and *n*-type Si cells [24–28]. It is thus necessary to get a deeper insight into the field-effect passivation effect of such configuration, as well as the plasmonic effect associated with the metallic NPs.

In this work, we showed that, by combining Ag-NPs with the $\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ stacks on implanted Si $n^+\text{-p}$ junctions, it is possible to dramatically reinforce the field-effect passivation through the local depleted space region associated with the Ag-NPs/Si local Schottky contacts, which is confirmed by photocurrent measurements. Ag-NP arrays with optimal size and coverage rate were fabricated by using NSL method while their optical properties have been investigated. Ag is the material of choice because of its low parasitic light absorption and good scattering properties [29]. It is worth noting that, neglecting the promising issue of plasmonic structures and passivation formed on the rear-side of Si junctions [30], we focus on the passivation effect of front-side in this work. Furthermore, finite-difference time-domain (FDTD) simulations were used to compare and explain the experimental results.

2. Methods

2.1. Device fabrication

Figure 1 shows the fabrication process of Ag-NPs based implanted Si $n^+\text{-p}$ junctions with surface passivation of $\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ stacks. Four-inch boron-doped *p*-type silicon (100) wafers with a resistivity of 5–10 Ωcm were used as substrate. The samples were cleaned using piranha solution

and distilled water before the realization of n^+ top layer. Phosphorous ions implantation was performed using a dose of 10^{14} at cm^{-2} at 180 KeV, followed by an annealing at 900 °C during 5 min to activate the dopants. A detailed description of the implantation process is described in our previous work [31].

Two-dimensional ordered Ag-NP arrays were deposited by combining NSL technique and thermal evaporation. Monodisperse SiO_2 nanospheres with different diameters D ($D = 2r$) ranging from 230 to 400 nm were purchased from Gmbh microparticles, and assembled into a close packed monolayer on Si wafer using Langmuir Blodgett (LB) technique, acting as the mask. The size and spacing of the NPs were controlled by isotropic reactive ion etching (RIE) of SiO_2 using a mixture of CHF_3 and O_2 with power of 100 W and pressure of 250 mTorr. Thermal evaporations of Ag were then performed on SiO_2 nanospheres to deposit Ag layers with different thicknesses ranging from 40 to 60 nm, while the substrate was kept at room temperature during evaporation. The SiO_2 nanospheres were then removed by using ultrasonic in isopropanol, giving an ordered array of Ag-NPs with triangular shape on the substrate.

First, an ultrathin Al_2O_3 tunneling layer with a thickness of 1.5 nm was deposited on the Ag-NP array by using ALD technique. The deposition was carried out in a TFS200 Beneq system with a thermal process. The reactants used were trimethylaluminum (TMA) and H_2O , while the growth temperature was 290 °C. Second, a $\text{SiN}_x\text{:H}$ layer with a thickness of 80 nm which corresponds to the value usually used in Si-solar cell industry, was deposited on the sample by using PECVD with a mixture of SiH_4 and NH_3 . The deposition temperature was 340 °C, while the pressure was 1 Torr and the power was 10 W. Sample was then annealed at 500 °C for 30 min to make H diffusing into Si. In addition, a sample with only $\text{SiN}_x\text{:H}$ passivation layer was fabricated as control device.

Finger electrodes of Ti/Au (20/800 nm) were deposited on the front-side by sputtering with a shadow mask after the opening of the $\text{SiN}_x\text{:H}$ coating by using RIE etching. The back contact was then deposited by evaporating Al films of 400 nm. Finally, the samples were annealed at 400 °C for 10 min to form Ohmic contact.

2.2. Characterization

The Ag-NP arrays were characterized by scanning electron microscopy (SEM, ZEISS ultra 55) to determine their size, spatial distribution and also surface coverage. The reflectance was measured using an UV–vis spectrophotometer (VARIAN CARY 5000), equipped with an integrating sphere (DRA-2500 LABSPHERE). The photoconductivity measurements were done using a monochromatic source (ORIEL) with a 200 W Tungsten light, allowing a spectroscopic analysis from 300 to 1200 nm. The photon flux was calibrated using a thermopile detector with a broad flat spectral response from 200 nm to 50 microns. All the photocurrent curves were therefore normalized and thus independent of the intensity of

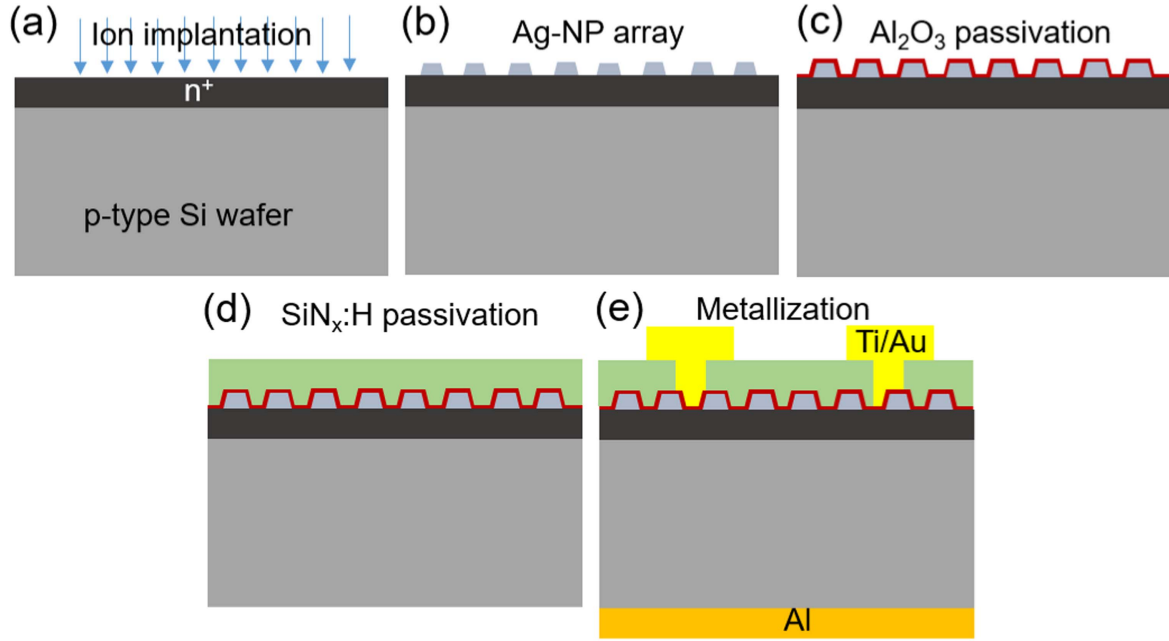


Figure 1. Schematic of fabrication process of Ag-NPs based implanted Si n⁺-p junction. (a) Formation of n⁺ top layer on p-type Si wafer, (b) Ag-NP arrays deposited by NSL technique and thermal evaporation, (c) deposition of Al₂O₃ tunneling layer by ALD, (d) deposition of SiN_x:H passivation layer by PECVD, (e) front and back side metallization.

the source. In order to increase the signal/noise ratio, the light flux was chopped at a frequency of 2.5 Hz and a lock-in detection was used.

The TEM analysis was done from cross sectional thin foils prepared by a focused ion beam (FIB) system. Prior to the ion thinning down, a carbon film and a platinum layer were deposited to protect the top surface of the sample. The TEM and HREM observations were done with a JEOL 2010 microscope operated at 200 kV and equipped with an energy dispersive x-ray (EDX) spectrometer (EDAX setup). The image processing was performed using DIGITALMICROGRAPH (GATAN). The images were taken with the electron beam parallel to the [011] direction of the Si (100) oriented substrate. In this orientation, the electron beam is parallel to the Ag particles/substrate interface.

2.3. FDTD simulations

FDTD simulations were performed using a commercially available package from OptiwaveTM to simulate the optical absorption of the samples. The OptiFDTD software is based on the FDTD algorithm proposed by K S Yee in (1966) [32], which introduced a modeling technique with second order central differences to solve the Maxwell equations applying a finite-difference approach. The FDTD algorithm can directly calculate the value of E (electric field intensity) and H (magnetic field intensity) at different points of the computational domain. The excitation field is a Gaussian modulated continuous wave with the center wavelength of 550 nm.

3. Results and discussion

Figure 2(a) shows a close packed monolayer of monodisperse SiO₂ nanospheres with diameter D ($D = 2r$) of 400 nm, assembled on Si substrate by using LB technique. The size and spacing of the NPs were further tuned by using isotropic RIE of SiO₂ [33, 34]. Ag films were then deposited on SiO₂ nanospheres as shown in figure 2(b). Figure 2(c) displays a top-view SEM image of the Ag deposition in one particular area. It can be observed that Ag filled well the voids of the nanosphere monolayer in a triangular shape. The honeycomb ordered array of Ag-NPs was finally obtained after removing the SiO₂ nanospheres, as it is shown in figure 2(d). The height of Ag-NPs depends on the evaporation thickness of Ag, which is well controlled in all samples.

NSL technique leads to an easy and precise control of the density of the NPs as well as their height, which is a great advantage compared with the dewetting of a thin metallic layer. In such a case, the density and the height of the NPs depend on the time, the temperature and the quantity of deposited metal, as well as the atomic structure of the surface, this last point being more difficult to control. Moreover, it is interesting to note that the following concept is independent of the metal used (in the limit of technological compatibility) and therefore is quite general.

Ag-NP array was modeled in FDTD simulations by considering the unit cell as shown in figure 3(a), and by implementing periodic boundary conditions in the array (x, y) plane. The relevant geometric parameters were the distance D_{ip} between the centers of two neighboring NPs, the thickness h and the size a_{SL} of each NP. The NPs were placed directly on

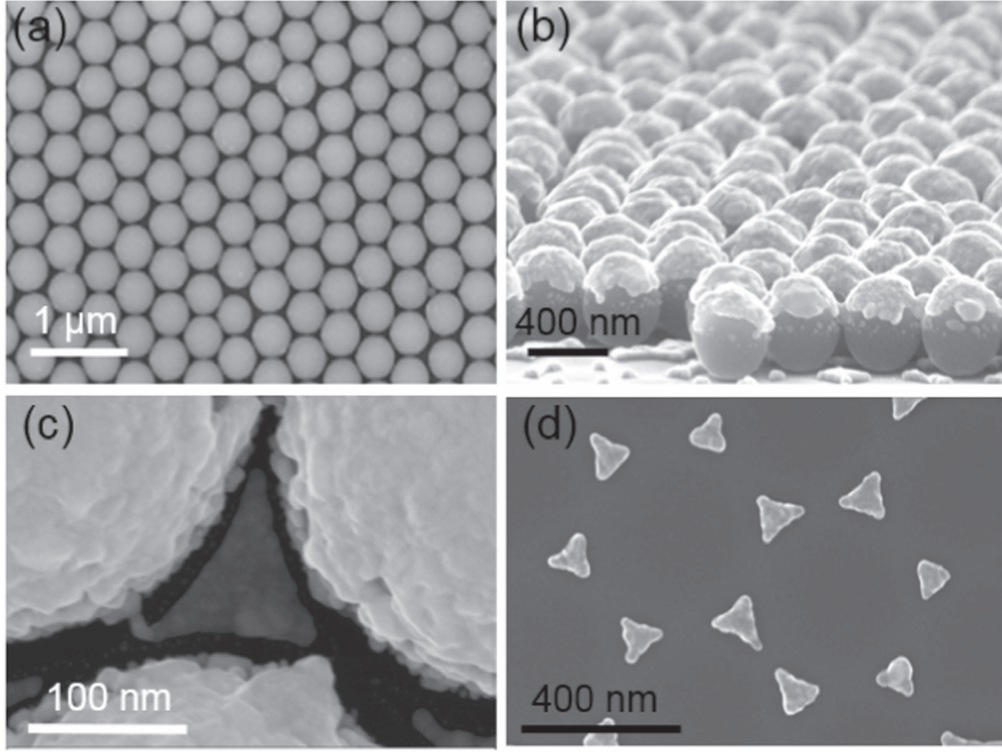


Figure 2. SEM images of (a) SiO₂ nanosphere monolayer. (b) SiO₂ nanospheres coated by Ag film after thermal evaporation. (c) Top-view SEM image of Ag deposition. (d) Ag-NP array after the removing of the SiO₂ nanospheres.

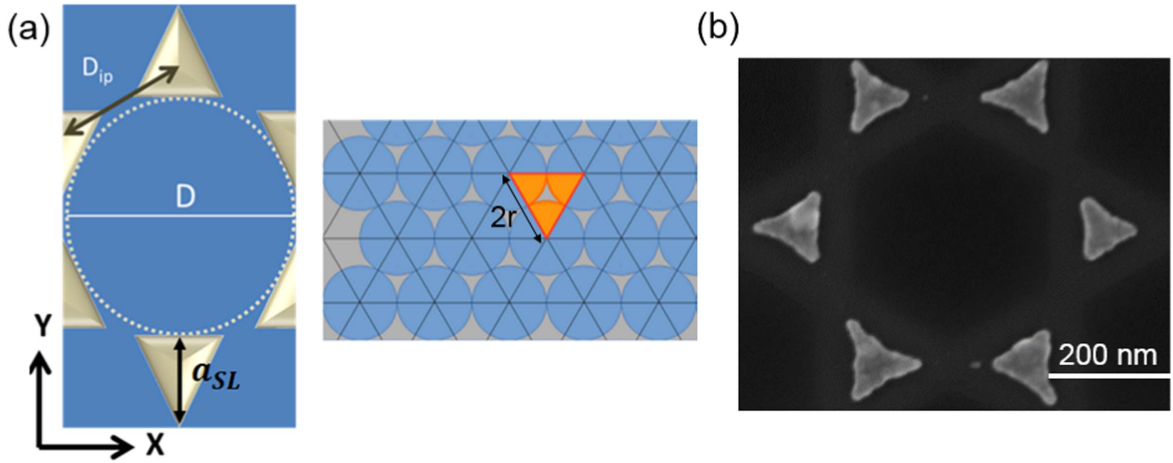


Figure 3. (a) Scheme for the FDTD simulation of the unit cell with the geometrical parameters of a metallic NP and an overview of the NP array. (b) SEM image of a part of Ag-NP array obtained from SiO₂ nanospheres with diameter D of 400 nm.

the substrate and the interface between the substrate and the medium was at the $z = 0$ plane. Over the NPs, the medium (air) was considered as semi-infinite. When necessary, Al₂O₃ and SiN_x:H layers were added. The semi-infinite conditions were necessary to hinder radiation back-scattering from the external. This was done by using perfectly matched layer sub-domains.

To obtain good light absorption of Ag-NP arrays and to avoid large shading effect, it is of great importance to optimize the surface coverage of the arrays which is reported to

be around 10% [12]. The theoretical surface coverage (Sc) of Ag-NPs fabricated by NSL technique can be easily calculated from the geometrical parameters of the array shown in figure 3(a). It is found that Sc does not depend on the diameter of SiO₂ nanospheres with a constant value of 9% close to the optimum value.

$$SC = \frac{A_{\text{triangle}} - 3A_{\text{circle}} / 6}{A_{\text{triangle}}} = \frac{\sqrt{3}r^2 - \frac{\pi r^2}{2}}{\sqrt{3}r^2} = 0.09 \quad (1)$$

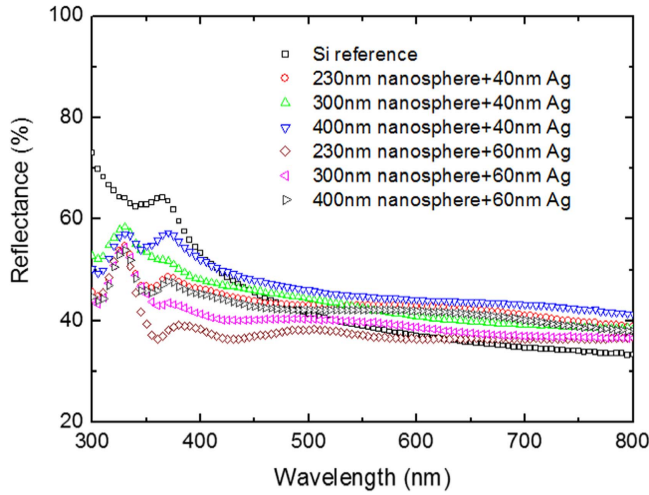


Figure 4. Reflectance of Ag-NP arrays for different Ag thicknesses (40 and 60 nm) and different nanosphere diameters (230, 300 and 400 nm).

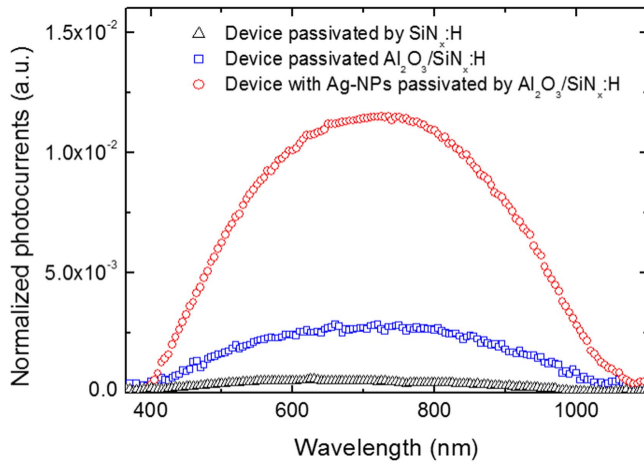


Figure 5. Photocurrent variations of devices with and without Ag-NPs passivated by SiNx:H and Al₂O₃/SiNx:H.

SEM observations coupled with MountainsMap™ software analysis were used to estimate the experimental surface coverage of Ag-NPs, which was measured to be around 10%, slightly higher than the theoretical value. The slight increase of experimental value can be explained by the non-perfect compactness of the SiO₂ nanosphere monolayer. An example of Ag-NP array obtained from SiO₂ nanospheres with diameter of 400 nm is shown in figure 3(b). The calculated grain surface coverage is 10.7%.

The optical properties of Ag-NP array with different densities (different nanosphere diameters) and Ag thicknesses were studied. It should be noted that the Ag thickness was kept less than that of the SiNx layer (80 nm) to ensure a good coverage of the passivation layer on Ag-NP arrays. Figure 4 shows the evolution of the reflectance spectra as a function of Ag thicknesses (40 and 60 nm) and nanosphere diameters (230, 300 and 400 nm).

The reflectance globally decreased when the density of Ag-NPs increased, in other words, when the diameter of SiO₂ nanospheres used to fabricate Ag-NPs decreased from 400 to

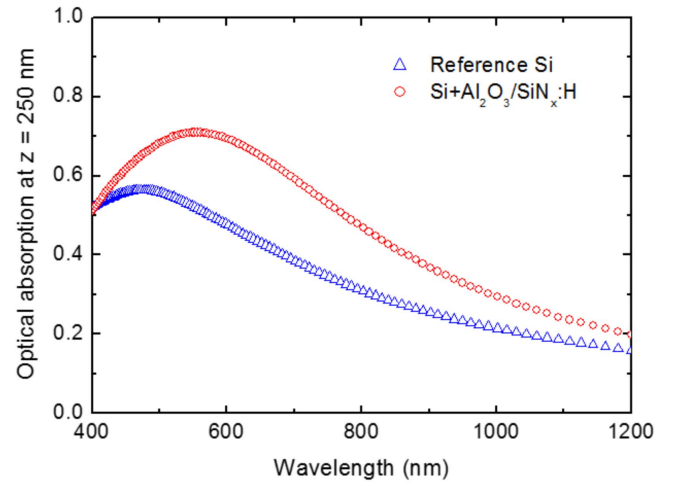


Figure 6. FDTD simulations of optical absorption at $z = 250$ nm for (a) Si substrate and (b) Si+Al₂O₃/SiNx:H stacks.

230 nm. The same trend was observed when the thickness of Ag-NPs was increased from 40 to 60 nm. As a result, the best Ag-NP array giving the minimum of reflectance with an average value of $\sim 42\%$ (lower than that of the Si reference $\sim 53\%$), was obtained with a high Ag-NPs density (fabricated from the smallest SiO₂ nanospheres 230 nm) and a thick Ag layer (60 nm). Such configuration was then applied in the following devices.

Passivation effect based on Al₂O₃/SiNx:H stacks deposited by means of ALD and PECVD techniques, including or not Ag NPs were studied by means of photoconductivity measurements. Figure 5 gives the associated photocurrent measurements.

The control device passivated by SiNx:H layer showed a very weak photocurrent. Indeed, during the fabrication of the metallic contacts on the devices, the etching of SiNx:H layer led to locally damaged and unpassivated contact surface which resulted in important serial resistance (greater than a few ohm cm²) with subsequent degradation of the electrical performances. The insertion of an Al₂O₃ tunneling layer became thus necessary, which is known to be a good passivation candidate for metallic contacts without affecting their ohmic nature [35]. Furthermore, the Al₂O₃ tunneling layer can be used not only as passivation layer but also as a control of the SiNx etching to avoid any degradation of the Si substrate, since Al₂O₃ is known to be hardly etched by RIE process. Such stack structure allows both good chemical and field effect passivation. The junction passivated by stacks of Al₂O₃ (1.5 nm) and SiNx:H (80 nm) exhibited an increasing of the photocurrent by a factor of 4 compared to that of the control device. In addition to the passivation effect, the embedded Ag-NPs in the Al₂O₃/SiNx:H stacks gave a gain of 5 on the photocurrent compared with the Al₂O₃/SiNx:H-passivated device without Ag-NPs. In total, the use of Ag-NPs combining with the Al₂O₃/SiNx:H stack passivation resulted in a typical gain of around 20 on photoconductivity comparing with the control device.

FDTD simulations of the optical absorption versus the different passivation process were performed to get a better

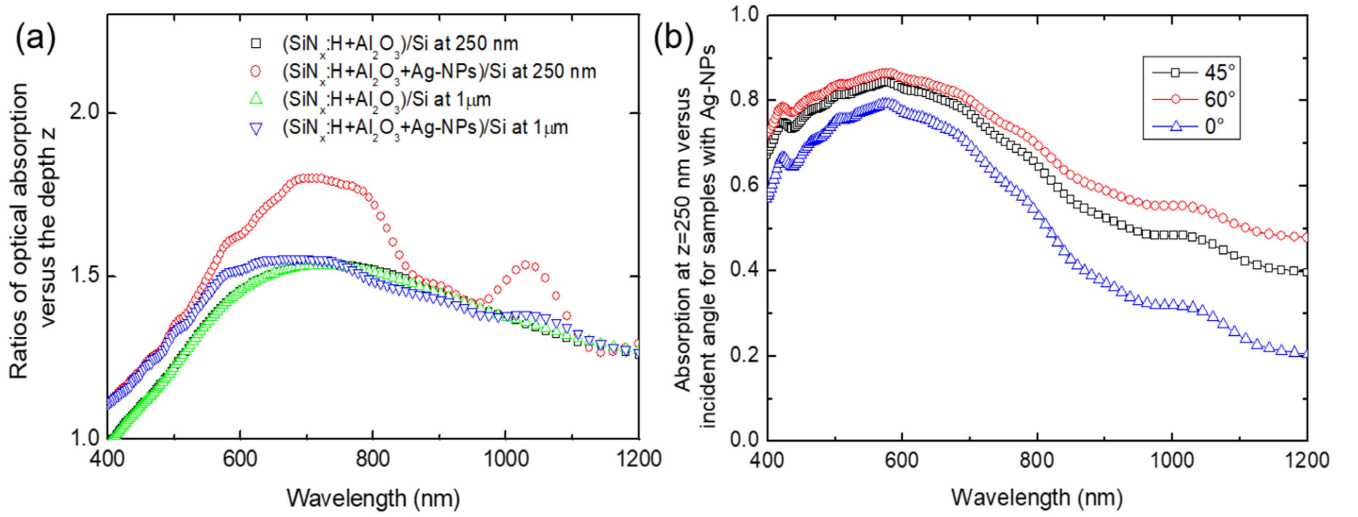


Figure 7. (a) FDTD simulations of the ratios of the optical absorption at depth $z = 250$ nm and $z = 1 \mu\text{m}$ for $(\text{Si}+\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H})$ and $(\text{Si}+\text{Ag-NPs}+\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H})$ over Si. (The Ag NPs size is 60 nm). (b) FDTD simulations of the optical absorption at $z = 250$ nm versus the incident angle for a sample with Ag-NPs.

understanding of the optical behavior of these devices. First, figure 6 gives the simulated optical absorption at $z = 250$ nm for reference Si and $\text{Si}+\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ stack. The spectra clearly show the optical enhancement for the use of $\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ stack, which can be mainly attributed to the effect of the optical adaptation of $\text{SiN}_x\text{:H}$ between air and Si. It is known that $\text{SiN}_x\text{:H}$ has an optical index n equal to 2, value between $n = 1$ (air) and $n_{\text{Si}} = 3.4$ (Si) and close to the optimal value, i.e. $\sqrt{nn_{\text{Si}}}$ equal to 1.84, while the addition of the ultrathin (1.5 nm) Al_2O_3 tunneling layer resulted in a slight modification of the optical absorption.

We have seen that the optical absorption is enhanced by the $\text{SiN}_x\text{:H}$ layer. Second, what is the impact of the Ag-NPs on the absorption? It is well known that Ag-NPs can weakly enhance the photovoltaic performances of devices according to scattering effect and waveguide effects through surface plasmonic modes of the Ag-NPs [36]. In order to quantify the improvement on the optical absorption associated with the Ag-NPs, FDTD simulations were performed for samples passivated by $\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ with and without Ag-NPs, as well as for the Si sample considered as the reference. Figure 7(a) shows the ratio of the absorption for $(\text{Si}+\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H})$ and $(\text{Si}+\text{Ag-NPs}+\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H})$ over Si at depth $z = 250$ nm and $z = 1 \mu\text{m}$. (This ratio is 1 for the reference Si).

An additional gain of absorption associated with Ag-NPs was observed near the surface with the depth of 250 nm where the plasmonic effect was prominent. The relative gain associated with the Ag-NPs compared to the reference samples is, integrated over all the wavelengths, of the order of 25%. The curve behaved with an oscillation shape. For Ag-NPs with a size of the order of 60 nm, there is an increased scattering efficiency leading to optical multireflections and therefore interference phenomena [37]. The metasurface associated with the Ag-NPs should also change the absorption versus the incident angle of the light. To check this point, we have calculated the absorption at $z = 250$ nm for samples with Ag-

NPs and for three incident angles: 0° , 45° and 60° , with respect to the normal direction to the surface. The results are given in figure 7(b).

We observe a small increase of the absorption as the incident angle increases. The integral of the absorption all over the wavelengths leads to relative increases with respect to the incident angle of 0° of 25% and 35% for 45° and 60° , respectively. So, versus the incident angle, there is a typical variation less than 35% on the relative gain of 25% associated with the Ag-NPs. This effect is not significant comparing with the 500% gain obtained on the photocurrent.

Two depth values of 250 nm and $1 \mu\text{m}$ were used in the simulations because they correspond to the middle of the n^+ layer and to the space charge region in the p-doped layer, respectively. In both cases, there is a strong electric field associated with the built in potential of the junction, which is favorable for the separation of photogenerated electron-hole pairs, and therefore, favorable to the photocurrent. The simulations showed an increase of the absorption in the space charge region, i.e. where the electron-hole pairs were separated and contributed to the photocurrent, in the limit of the recombination process. This explained partially the increase of the photocurrent. Nevertheless, the main enhancement was due to the $\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H}$ stacks, while the addition of the Ag-NPs had a weak effect on the optical absorption. Due to their size, they mainly diffused the light into the $\text{SiN}_x\text{:H}$ layer and only a small gain could be achieved through plasmonic effect. One possible way to increase the plasmonic effect is to try to get better tip effect on the triangular shape of the Ag NPs: tip effect will increase the local electric field and therefore, the coupling between the Ag-NPs, with the possibility to create new collective (plasmonic) effect. This better shape needs to play with the temperature of the substrate and with the flux of Ag during the metal deposition.

After the aforementioned analyses, we propose herein that the increase of photocurrent between $(\text{Si}+\text{Ag-NPs}+\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H})$ and $(\text{Si}+\text{Al}_2\text{O}_3/\text{SiN}_x\text{:H})$ is mainly associated with the

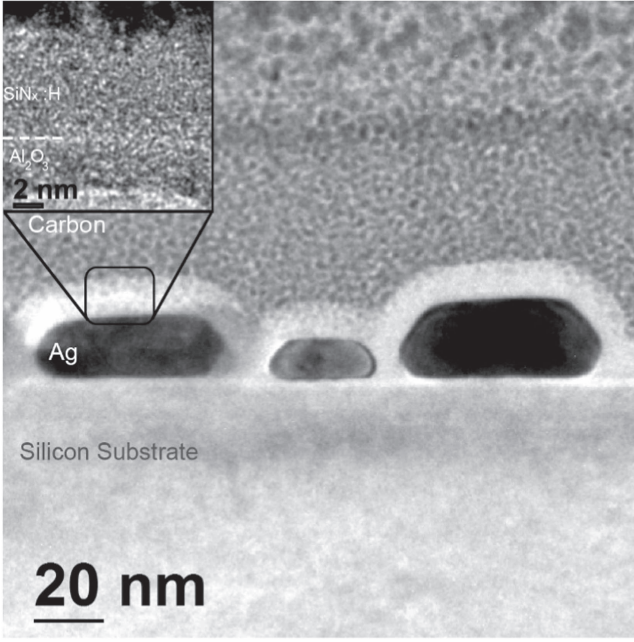


Figure 8. TEM image of the Si+Ag-NPs+Al₂O₃/SiN_x:H stacks. In the inset is shown the interface between Ag-NP and Al₂O₃/SiN_x:H layers under unfocused approach to separate both layers. The carbon layer on top of the Al₂O₃/SiN_x:H stacks has been added for FIB preparation.

Ag-NPs/Si contacts that play the role of local Schottky junctions inducing a strong electric field passivation. The photocurrent can be semi-quantitatively linked to one key parameter of the electric field passivation effect, the concentration D_{it} of the fixed charges located in the oxide layer. It is known that an electric field passivation is associated with fixed charges localized in the oxide layer (in our case, Al₂O₃ layer). The passivation effect is due to a depleted region with a depth Z , which prevents the recombination of photocarriers on the surface. D_{it} , Z and N_D (the Si doping level) can be simply bounded by the relation as follows:

$$D_{it} = Z * N_D. \quad (2)$$

The passivation effect can be therefore quantified through Z or D_{it} . Concerning the Al₂O₃ layer, taking the average doping level N_D as 10^{18} cm^{-3} deduced from SIMS measurements [31] and D_{it} ranging from a few 10^{11} to a few 10^{12} cm^{-2} [38, 39], the associated depth of Si depleted zone, $Z_{\text{Al}_2\text{O}_3}$, according to (2), varies typically from 5 to 10 nm.

For the Ag-NPs deposited on a clean Si surface, local Schottky metal/Si contacts are created, as shown in the TEM image of figure 8 (in this image, a 8 nm SiN_x layer on 1.5 nm thick Al₂O₃ layer was used). Indeed TEM micrograph shows a typical Ag-NPs network covered by the Al₂O₃/SiN_x:H stacked layers deposited by ALD and PECVD. One can see the perfect conformal layers covering the metallic NPs. Concerning the Ag-NPs dimensions, most of them are about 54 nm long and 20 nm height with sometimes, as evidenced in this figure, the presence of small $\sim 12 \times 30 \text{ nm}^2$ Ag-NP. In the inset is shown a zoom of the interface between Ag-NPs and the Al₂O₃/SiN_x:H stacked layers. For distinguishing the two layers, the micrograph has been captured under

unfocused conditions and dotted lines have been added for helping the reader. The Al₂O₃ ALD and SiN_x:H PECVD layers are 1.5 and 8.0 nm thick, respectively. EDX analyses using a 1 nm probe performed on both layers confirmed the presence and the absence of Al element in the ALD and SiN_x:H layers, respectively.

Figure 9(a) illustrates a schematic representation of the Ag-NPs/Si contact. The depleted zone associated with the contact plays the same role as a depleted region associated with fixed charges. Its extension W is given by [1]:

$$w = \sqrt{\frac{2\varepsilon_0\varepsilon_r V_b}{qN_D}}, \quad (3)$$

where ε_0 is the dielectric constant of the vacuum, ε_r is the relative dielectric constant of Si, equal to 11.7, q is the electron charge and V_b is the Ag/Si(n) Schottky barrier height equal to 0.75 eV [1]. Over 500 nm depth, the average value of N_D is 10^{18} cm^{-3} , leading to W equal to 35 nm.

The extension of this depleted layer is illustrated in figure 9(b) with over a distance of W . The effective depleted surface can be associated with a surface based on NPs with an effective size a_{sl} increased by $2W$. The surface S of a NP is $0.04D^2$ and $a_{sl} = 0.233D$ [40], giving $S = 0.736 a_{sl}^2$. The effective surface S_{eff} of a depleted region associated with a NP is therefore $0.736 (a_{sl} + 2W)^2$. The gain for the passivated layer, associated with the Ag-NPs space charge region is therefore S_{eff}/S . Starting with a Ag surface coverage r , the final effective Schottky passivated surface coverage r_{eff} is:

$$r_{\text{eff}} = r \left(1 + \frac{2W}{a_{sl}} \right)^2. \quad (4)$$

Taking the experimental surface coverage r of Ag-NPs to 10%, with $a_{sl} = 55 \text{ nm}$ for $D = 230 \text{ nm}$, we calculate r_{eff} equal to 0.53. As the remaining 47% of the surface is also covered by Al₂O₃, the equivalent depleted depth Z_{AgNPs} associated with embedded Ag-NPs, calculated all over the surface S , is given by the relation:

$$S * Z_{\text{AgNPs}} = S * (0.53 W + 0.47 Z_{\text{Al}_2\text{O}_3}). \quad (5)$$

This leads to Z_{AgNPs} ranging from 20.9 to 23.2 nm, i.e. an average value of $\sim 22 \text{ nm}$, which has to be compared with $Z_{\text{Al}_2\text{O}_3}$ ranging from 5 to 10 nm. As described in the previous section, the comparison between two passivation processes can be related to the ratio of the depleted regions, equivalent to a ratio of D_{it} . Thus, the addition of embedded Ag-NPs induces an equivalent increase of D_{it} by a typical factor ranging from $22/(5-10)$, i.e. from 2.2 to 4.4. Finally, the photocurrent I can be now linked to the passivation effect. Indeed, I is inversely proportional to the effective surface recombination velocity Se , while Se varies exponentially with D_{it} [24].

$$I\%(1/Se)\% \exp(\beta D_{it}) \quad (6)$$

with β depending on the sample and on the sign of the fixed charges (the product βD_{it} is positive). It typically ranges from 0.3 to 1 (values deduced by fitting Se versus D_{it}). Taking for example $\beta = 0.5$, we obtain a gain for the photocurrent ranging from 3 to 9. The measured gain of 5 (figure 5) is in that range, which is thus consistent with the calculated values. As a

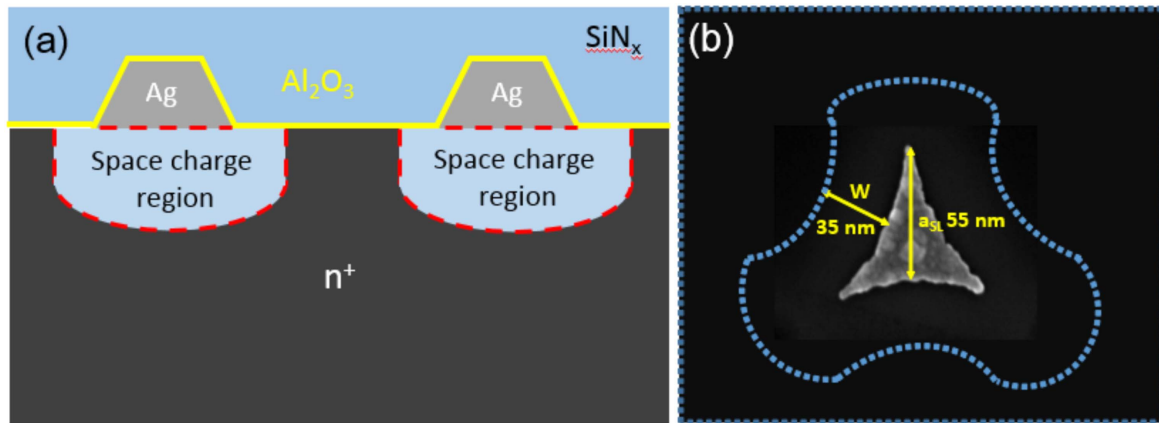


Figure 9. (a) Schematic representation of Ag-NPs/Si Schottky contact. (b) Top-view schematic associated depleted zone on the Ag-NP.

result, such analysis allows us to describe, explain and confirm quantitatively the enhanced field effect passivation induced by the local Schottky Ag-NPs/Si contacts.

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4. Conclusion

In conclusion, we have developed a composite structure of ordered Ag-NP arrays embedded in ALD- Al_2O_3 /PECVD- SiN_x :H stacks to improve the absorption and the field effect passivation of Si junctions. The density and surface coverage of Ag-NPs were well controlled by using a nanosphere lithography technique to achieve optimal light absorption. Photoconductivity studies of junctions were performed, while the best result was obtained in junctions with Ag-NPs embedded in Al_2O_3 / SiN_x :H stacks, giving five times gain comparing with the only Al_2O_3 / SiN_x :H-passivated junction. Finally, FDTD simulations and semi-quantitative calculations demonstrated that such improvement was mainly due to the enhanced field effect passivation through the depleted region associated with the Ag-NPs/Si Schottky contacts, in addition to a weak plasmonic effect induced by Ag-NPs. Note that this concept is general and can be extended to other metal. The results achieved here demonstrate that the integration of Ag-NPs in an effective passivation stacks can be easily feasible, and is a really promising approach to increase significantly the efficiency of future solar cells.

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